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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	1057
Number of Logic Elements/Cells	10570
Total RAM Bits	920448
Number of I/O	362
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep1sgx10df672i6n">https://www.e-xfl.com/product-detail/intel/ep1sgx10df672i6n</a>



Each Stratix GX transceiver channel consists of a transmitter and receiver. The transmitter contains the following:

- Transmitter PLL
- Transmitter phase compensation FIFO buffer
- Byte serializer
- 8B/10B encoder
- Serializer (parallel to serial converter)
- Transmitter output buffer

The receiver contains the following:

- Input buffer
- Clock recovery unit (CRU)
- Deserializer
- Pattern detector and word aligner
- Rate matcher and channel aligner
- 8B/10B decoder
- Receiver logic array interface

You can set all the Stratix GX transceiver functions through the Quartus II software. You can set programmable pre-emphasis, programmable equalizer, and programmable  $V_{OD}$  dynamically as well. Each Stratix GX transceiver channel is also capable of BIST generation and verification in addition to various loopback modes. [Figure 2–2](#) shows the block diagram for the Stratix GX transceiver channel.

Stratix GX transceivers provide physical coding sublayer (PCS) and physical media attachment (PMA) implementation for protocols such as 10-gigabit XAUI and GIGE. The PCS portion of the transceiver consists of the logic array interface, 8B/10B encoder/decoder, pattern detector, word aligner, rate matcher, channel aligner, and the BIST and pseudo-random binary sequence pattern generator/verifier. The PMA portion of the transceiver consists of the serializer/deserializer, the CRU, and the I/O buffers.

## Transmitter Path

This section describes the data path through the Stratix GX transmitter (see [Figure 2–2](#)). Data travels through the Stratix GX transmitter via the following modules:

- Transmitter PLL
- Transmitter phase compensation FIFO buffer
- Byte serializer
- 8B/10B encoder
- Serializer (parallel to serial converter)
- Transmitter output buffer

### *Transmitter PLL*

Each transceiver block has one transmitter PLL, which receives the reference clock and generates the following signals:

- High-speed serial clock used by the serializer
- Slow-speed reference clock used by the receiver
- Slow-speed clock used by the logic array (divisible by two for double-width mode)

The INCLK clock is the input into the transmitter PLL. There is one INCLK clock per transceiver block. This clock can be fed by either the REFCLKB pin, PLD routing, or the inter-transceiver routing line. See the section [“Stratix GX Clocking” on page 2–30](#) for more information about the inter-transceiver lines.

The transmitter PLL in each transceiver block clocks the circuits in the transmit path. The transmitter PLL is also used to train the receiver PLL. If no transmit channels are used in the transceiver block, the transmitter PLL can be turned off. [Figure 2–3](#) is a block diagram of the transmitter PLL.

The transmitter PLL can support up to 3.1875 Mbps. The input clock frequency for –5 and –6 speed grade devices is limited to 650 MHz if you use the REFCLKB pin or to 325 MHz if you use the other clock routing resources. For –7 speed grade devices, the maximum input clock frequency is 312.5 MHz with the REFCLKB pin, and the maximum is 156.25 MHz for all other clock routing resources. An optional PLL\_LOCKED port is available to indicate whether the transmitter PLL is locked to the reference clock. The transmitter PLL has a programmable loop bandwidth that can be set to low or high. The loop bandwidth parameter can be statically set in the Quartus II software.

Table 2–2 lists the adjustable parameters in the transmitter PLL.

<b>Table 2–2. Transmitter PLL Specifications</b>	
<b>Parameter</b>	<b>Specifications</b>
Input reference frequency range	25 MHz to 650 MHz
Data rate support	500 Mbps to 3.1875 Gbps
Multiplication factor (W)	2, 4, 5, 8, 10, 16, or 20 (1)
Bandwidth	Low, high

**Note to Table 2–2:**

- (1) Multiplication factors 2 and 5 can only be achieved with the use of the pre-divider on the REFCLKB pin.

### *Transmitter Phase Compensation FIFO Buffer*

The transmitter phase compensation FIFO buffer resides in the transceiver block at the PLD boundary. This FIFO buffer compensates for the phase differences between the transmitter reference clock (inc1k) and the PLD interface clock (tx\_coreclk). The phase difference between the two clocks must be less than 360°. The PLD interface clock must also be frequency locked to the transmitter reference clock. The phase compensation FIFO buffer is four words deep and cannot be bypassed.

### *Byte Serializer*

The byte serializer takes double-width words (16 or 20 bits) from the PLD interface and converts them to a single width word (8 or 10 bits) for use in the transceiver. The transmit data path after the byte serializer is single width (8 or 10 bits). The byte serializer is bypassed when single width mode (8 or 10 bits) is used at the PLD interface.

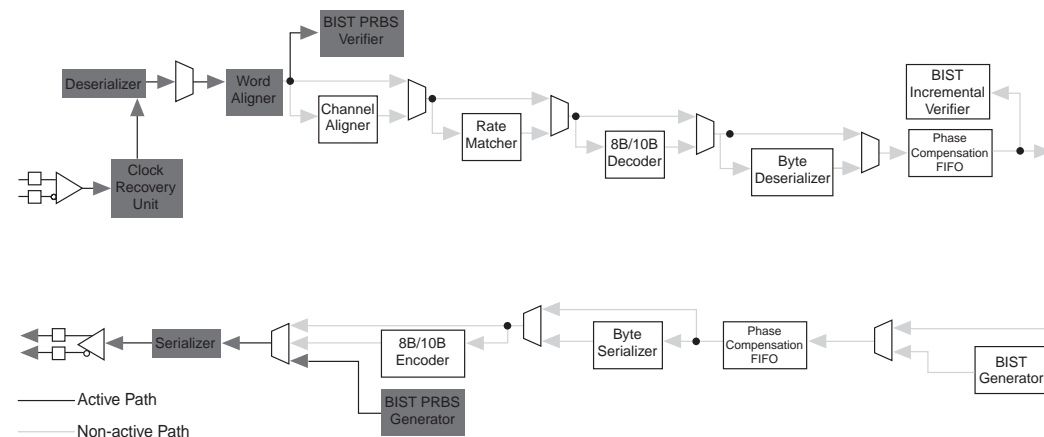
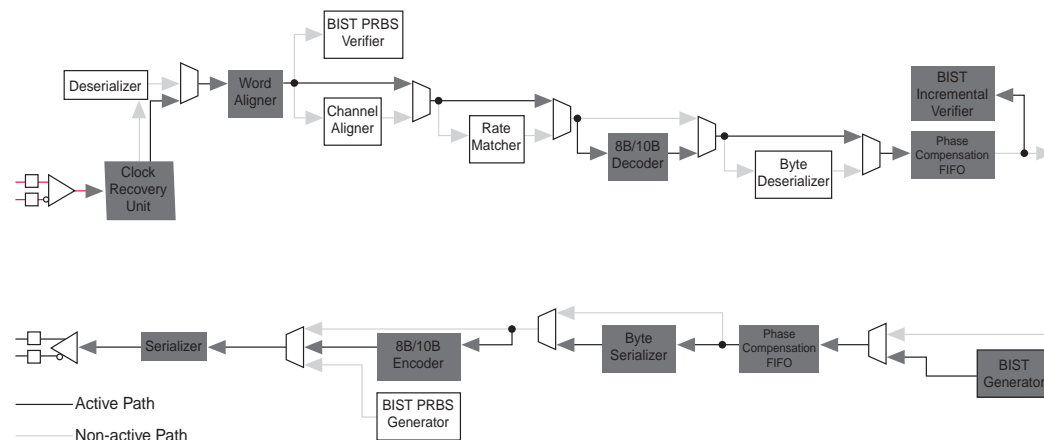
**Figure 2–24. BIST PRBS Data Path****Figure 2–25. BIST Incremental Data Path**

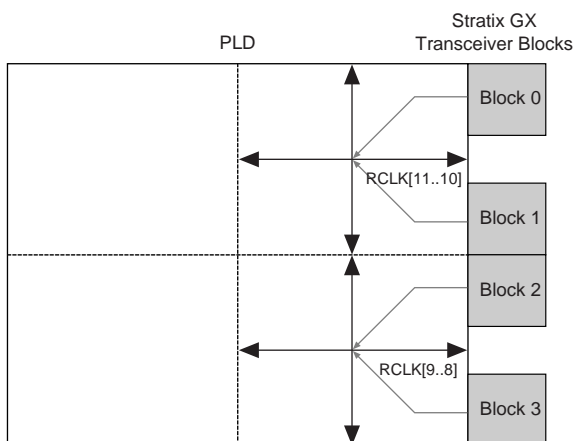
Table 2–9 shows the BIST data output and verifier alignment pattern.

<b>Table 2–9. BIST Data Output &amp; Verifier Alignment Pattern (Part 1 of 2)</b>			
<b>BIST Mode</b>	<b>Output</b>	<b>Polynomials</b>	<b>Verifier Word Alignment Pattern</b>
PRBS 8-bit	$2^8 - 1$	$x^8 + x^7 + x^5 + x^3 + 1$	1000000011111111
PRBS 10-bit	$2^{10} - 1$	$x^{10} + x^7 + 1$	1111111111

The receiver PLL can also drive the fast regional, regional clocks, and local routing adjacent to the associated transceiver block. Figures 2–28 through 2–31 show which fast regional and regional clock resource can be used by the recovered clock.

In the EP1SGX25 device, the receiver PLL recovered clocks from transceiver blocks 0 and 1 drive RCLK[1..0] while transceiver blocks 2 and 3 drive RCLK[7..6]. The regional clocks feed logic in their associated regions.

**Figure 2–28. EP1SGX25 Receiver PLL Recovered Clock to Regional Clock Connection**



In addition, the receiver PLL's recovered clocks can drive fast regional lines (FCLK) as shown Figure 2–29. The fast regional clocks can feed logic in their associated regions.

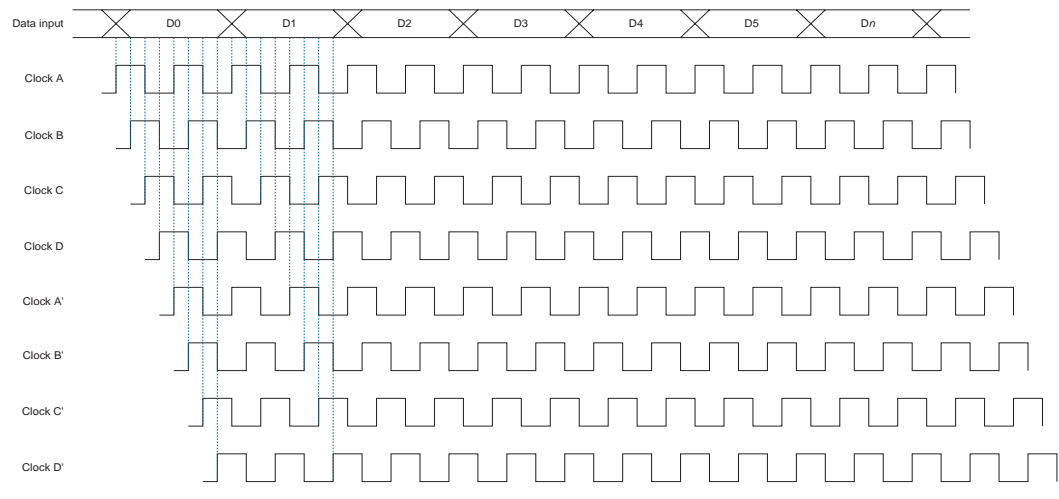
## High-Speed Serial Bus Protocols

With wide, serial data rate range, Stratix GX devices can support multiple, high-speed serial bus protocols. [Table 2–12](#) shows some of the protocols that Stratix GX devices can support.

***Table 2–12. High-Speed Serial Bus Protocols***

<b>Bus Transfer Protocol</b>	<b>Stratix GX (Gbps) (Supports up to 3.1875 Gbps)</b>
SONET backplane	2.488
10 Gigabit Ethernet XAUI	3.125
10 Gigabit fibre channel	3.1875
InfiniBand	2.5
Fibre channel (1G, 2G)	1.0625, 2.125
Serial RapidIO™	1.25, 2.5, 3.125
PCI Express	2.5
SMPTE 292M	1.485



**Figure 3–9. Fast PLL Clocks & Data Input***Protocols, Training Pattern & DPA Lock Time*

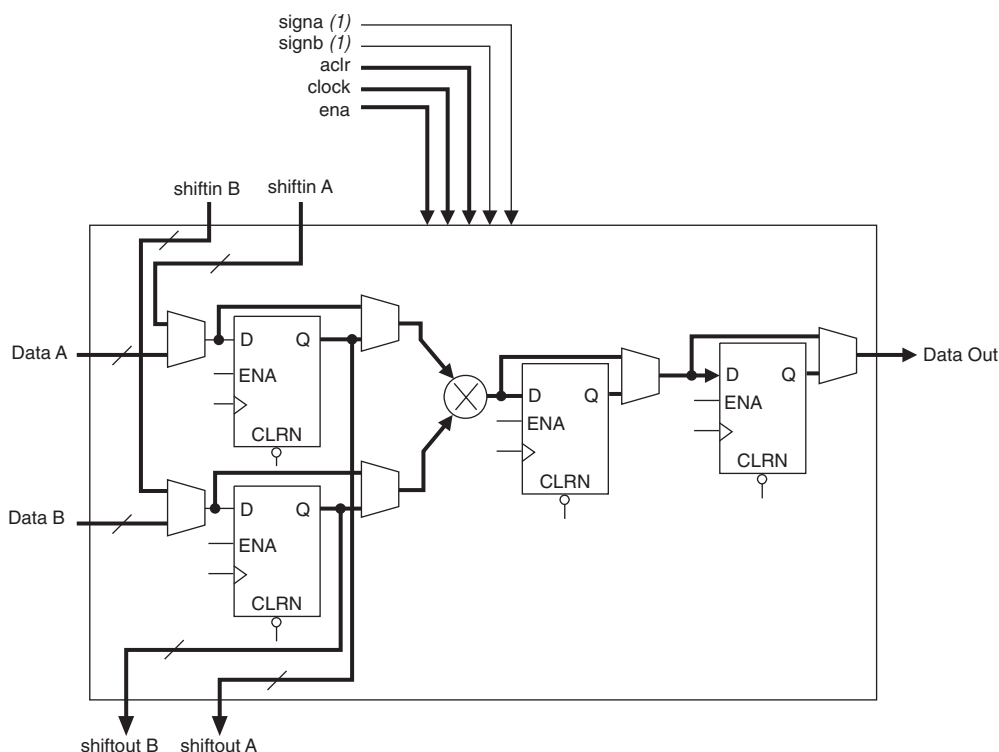
The dynamic phase aligner uses a fast PLL for clock multiplication, and the dynamic phase selector for the phase detection and alignment. The dynamic phase aligner uses the high-speed clock out of the dynamic phase selector to deserialize high-speed data and the receiver's source synchronous operations.

At each rising edge of the clock, the dynamic phase selector determines the phase difference between the clock and the data and automatically compensates for the phase difference between the data and clock.

## TriMatrix Memory

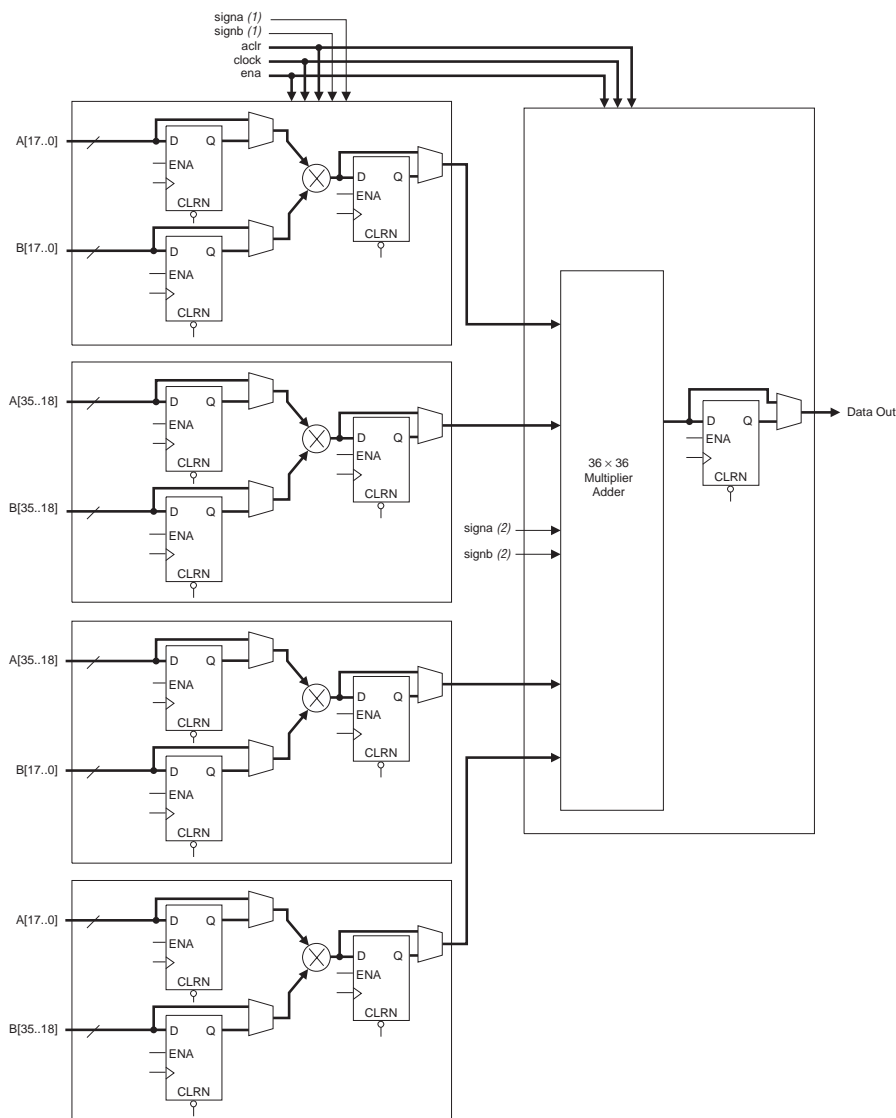
TriMatrix memory consists of three types of RAM blocks: M512, M4K, and M-RAM blocks. Although these memory blocks are different, they can all implement various types of memory with or without parity, including true dual-port, simple dual-port, and single-port RAM, ROM, and FIFO buffers. Table 4–2 shows the size and features of the different RAM blocks.

<b>Table 4–2. TriMatrix Memory Features (Part 1 of 2)</b>			
<b>Memory Feature</b>	<b>M512 RAM Block (32 × 18 Bits)</b>	<b>M4K RAM Block (128 × 36 Bits)</b>	<b>M-RAM Block (4K × 144 Bits)</b>
Maximum performance	(1)	(1)	(1)
True dual-port memory		✓	✓
Simple dual-port memory	✓	✓	✓
Single-port memory	✓	✓	✓
Shift register	✓	✓	
ROM	✓	✓	(2)
FIFO buffer	✓	✓	✓
Byte enable		✓	✓
Parity bits	✓	✓	✓
Mixed clock mode	✓	✓	✓
Memory initialization	✓	✓	
Simple dual-port memory mixed width support	✓	✓	✓
True dual-port memory mixed width support		✓	✓
Power-up conditions	Outputs cleared	Outputs cleared	Outputs unknown
Register clears	Input and output registers	Input and output registers	Output registers
Mixed-port read-during-write	Unknown output/old data	Unknown output/old data	Unknown output

**Figure 4–34. Simple Multiplier Mode****Note to Figure 4–34:**

(1) These signals are not registered or registered once to match the data path pipeline.

DSP blocks can also implement one  $36 \times 36$ -bit multiplier in multiplier mode. DSP blocks use four  $18 \times 18$ -bit multipliers combined with dedicated adder and internal shift circuitry to achieve 36-bit multiplication. The input shift register feature is not available for the  $36 \times 36$ -bit multiplier. In  $36 \times 36$ -bit mode, the device can use the register that is normally a multiplier-result-output register as a pipeline stage for the  $36 \times 36$ -bit multiplier. Figure 4–35 shows the  $36 \times 36$ -bit multiply mode.

**Figure 4–35.  $36 \times 36$  Multiply Mode****Notes to Figure 4–35:**

- (1) These signals are not registered or registered once to match the pipeline.
- (2) These signals are not registered, registered once, or registered twice for latency to match the pipeline.

**Table 4–18. Stratix GX Enhanced PLL & Fast PLL Features (Part 2 of 2)** *Notes (1)–(8)*

Feature	Enhanced PLL	Fast PLL
Number of external clock outputs	Four differential/eight singled-ended or one single-ended (6)	(7)
Number of feedback clock inputs	4 (8)	

**Notes to Table 4–18:**

- (1) The maximum count value is 1024, with a 50% duty cycle setting on the counter. The maximum count value for any other duty cycle setting is 512.
- (2) For fast PLLs, *m* and post-scale counters range from 1 to 32.
- (3) The smallest phase shift is determined by the VCO period divided by 8.
- (4) For degree increments, Stratix GX devices can shift all output frequencies in increments of at least 45°. Smaller degree increments are possible depending on the frequency and divide parameters.
- (5) PLLs 7 and 8 have two output ports per PLL. PLLs 1 and 2 have three output ports per PLL.
- (6) Every Stratix GX device has two enhanced PLLs (PLLs 5 and 6) with eight single-ended or four differential outputs each. Two additional enhanced PLLs (PLLs 11 and 12) in EP1SGX40 devices each have one single-ended output.
- (7) Fast PLLs can drive to any I/O pin as an external clock. For high-speed differential I/O pins, the device uses a data channel to generate `txclkout`.
- (8) Every Stratix GX device has two enhanced PLLs with one single-ended or differential external feedback input per PLL.

Figure 4–48 shows a top-level diagram of the Stratix GX device and the PLL floorplan.

pair of output pins (four pins total) has dedicated VCC and GND pins to reduce the output clock's overall jitter by providing improved isolation from switching I/O pins.

For PLLs 5 and 6, each pin of a single-ended output pair can either be in phase or 180° out of phase. The clock output pin pairs support the same I/O standards as standard output pins (in the top and bottom banks) as well as LVDS, LVPECL, 3.3-V PCML, HyperTransport technology, differential HSTL, and differential SSTL. Table 4–19 shows which I/O standards the enhanced PLL clock pins support. When in single-ended or differential mode, the two outputs operate off the same power supply. Both outputs use the same standards in single-ended mode to maintain performance. You can also use the external clock output pins as user output pins if external enhanced PLL clocking is not needed.

**Table 4–19. I/O Standards Supported for Enhanced PLL Pins (Part 1 of 2)**

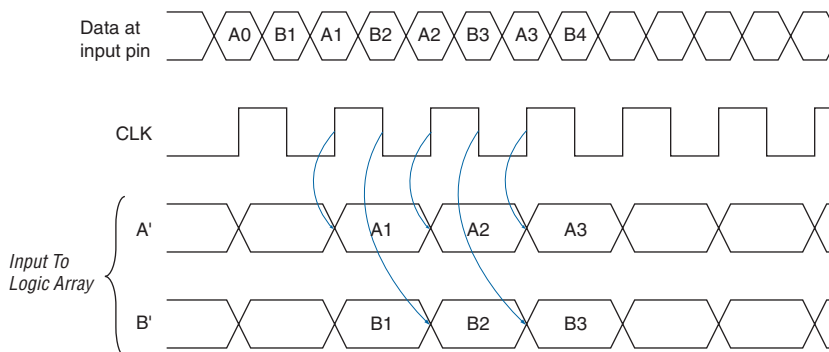
I/O Standard	Input			Output
	INCLK	FBIN	PLENABLE	EXTCLK
LVTTL	✓	✓	✓	✓
LVC MOS	✓	✓	✓	✓
2.5 V	✓	✓		✓
1.8 V	✓	✓		✓
1.5 V	✓	✓		✓
3.3-V PCI	✓	✓		✓
3.3-V PCI-X	✓	✓		✓
LVPECL	✓	✓		✓
3.3-V PCML	✓	✓		✓
LVDS	✓	✓		✓
HyperTransport technology	✓	✓		✓
Differential HSTL	✓			✓
Differential SSTL				✓
3.3-V GTL	✓	✓		✓
3.3-V GTL+	✓	✓		✓
1.5-V HSTL class I	✓	✓		✓
1.5-V HSTL class II	✓	✓		✓
SSTL-18 class I	✓	✓		✓
SSTL-18 class II	✓	✓		✓
SSTL-2 class I	✓	✓		✓
SSTL-2 class II	✓	✓		✓

Figure 4-64 shows an IOE configured for DDR input. Figure 4-65 shows the DDR input timing diagram.

*Note (1)*

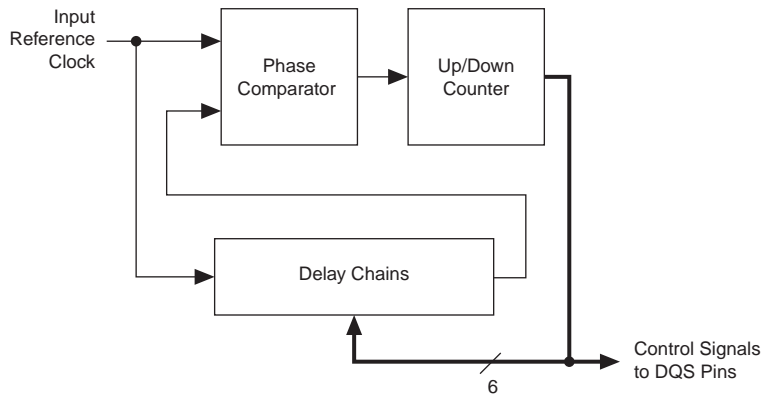


- (1) All input signals to the IOE can be inverted at the IOE.
- (2) This signal connection is only allowed on dedicated DQ function pins.
- (3) This signal is for dedicated DQS function pins only.

**Figure 4–65. Input Timing Diagram in DDR Mode**

When using the IOE for DDR outputs, the two output registers are configured to clock two data paths from LEs on rising clock edges. These output registers are multiplexed by the clock to drive the output pin at a  $\times 2$  rate. One output register clocks the first bit out on the clock high time, while the other output register clocks the second bit out on the clock low time. [Figure 4–66](#) shows the IOE configured for DDR output. [Figure 4–67](#) shows the DDR output timing diagram.



**Figure 4–68. Simplified Diagram of the DQS Phase-Shift Circuitry**

See the *External Memory Interfaces* chapter of the *Stratix GX Device Handbook, Volume 2* for more information on external memory interfaces.

### Programmable Drive Strength

The output buffer for each Stratix GX device I/O pin has a programmable drive strength control for certain I/O standards. The LVTTTL and LVC MOS standard has several levels of drive strength that the user can control. SSTL-3 class I and II, SSTL-2 class I and II, HSTL class I and II, and 3.3-V GTL+ support a minimum setting, the lowest drive strength that guarantees the  $I_{OH}/I_{OL}$  of the standard. Using minimum settings provides signal slew rate control to reduce system noise and signal overshoot.

**Table 6–6. Stratix GX Transceiver Block On-Chip Termination (Part 2 of 2)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Refclk <sub>b</sub>	Dedicated transceiver clock termination	Commercial and industrial, 100-Ω setting	103	108	113	Ω
		Commercial and industrial, 120-Ω setting	120	128	134	Ω
		Commercial and industrial, 150-Ω setting	149	158	167	Ω

**Notes to Tables 6–1 through 6–6:**

- See the [Operating Requirements for Altera Devices Data Sheet](#).
- Conditions beyond those listed in [Table 6–1](#) may cause permanent damage to a device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.
- Minimum DC input is –0.5 V. During transitions, the inputs may undershoot to –2.0 V or overshoot to 4.6 V for input currents less than 100 mA and periods shorter than 20 ns. (The information in this note does not include the transceiver pins. See [note 13](#) for information about the transient voltage on the transceiver pins.)
- Maximum  $V_{CC}$  rise time is 100 ms, and  $V_{CC}$  must rise monotonically.
- $V_{CCIO}$  maximum and minimum conditions for LVPECL, LVDS, and 3.3-V PCML are shown in parentheses.
- All pins, including dedicated inputs, clock, I/O, and JTAG pins, may be driven before  $V_{CCINT}$  and  $V_{CCIO}$  are powered.
- Typical values are for  $T_A = 25^\circ\text{C}$ ,  $V_{CCINT} = 1.5\text{ V}$ , and  $V_{CCIO} = 1.5\text{ V}$ , 1.8 V, 2.5 V, and 3.3 V.
- This value is specified for normal device operation. The value may vary during power-up. This applies for all  $V_{CCIO}$  settings (3.3, 2.5, 1.8, and 1.5 V).
- Pin pull-up resistance values decrease if an external source drives the pin higher than  $V_{CCIO}$ .
- The device can tolerate prolonged operation at this absolute maximum, as long as the maximum specification is not violated.
- Each usable quad requires its own  $R_{REF}$  resistor path to ground. For example, the “D” in the EP1SGX25DC1020 device code means it has two usable quad so two different  $R_{REF}$  pins must be connected to a  $R_{REF}$  resistor each to ground. The DC signal on the  $R_{REF}$  pin must be as clean as possible. Ensure that no noise is coupled to this pin.
- The Stratix GX device’s recommended operating conditions do not include the transceiver. Refer to [Tables 6–4 to 6–7](#).
- Minimum DC input to the transceiver pins is –0.5 V. During transitions, the transceiver pins may undershoot to –0.5 V or overshoot to 3.5 V for input currents less than 100 mA and periods shorter than 20 ns.

**Table 6–7. Stratix GX Transceiver Block AC Specification (Part 1 of 7)**

Symbol / Description	Conditions	-5 Commercial Speed Grade (1)			-6 Commercial & Industrial Speed Grade (1)			-7 Commercial & Industrial Speed Grade (1)			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Power per quadrant (PCS + PMA)	3.125 Gbps, 400-mV $V_{od}$ 0 pre-emphasis		450			450					mW

**Table 6–68. EP1SGX40 Column Pin Global Clock External I/O Timing Parameters**

Symbol	-5 Speed Grade		-6 Speed Grade		-7 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{INSU}}$	2.033		2.184		2.451		ns
$t_{\text{INH}}$	0.000		0.000		0.000		ns
$t_{\text{OUTCO}}$	2.000	5.689	2.000	6.116	2.000	7.010	ns
$t_{\text{INSUPLL}}$	1.228		1.278		1.415		ns
$t_{\text{INHPLL}}$	0.000		0.000		0.000		ns
$t_{\text{OUTCOPLL}}$	0.500	2.594	0.500	2.732	0.500	3.113	ns

**Table 6–69. EP1SGX40 Row Pin Fast Regional Clock External I/O Timing Parameters**

Symbol	-5 Speed Grade		-6 Speed Grade		-7 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{INSU}}$	2.450		2.662		3.046		ns
$t_{\text{INH}}$	0.000		0.000		0.000		ns
$t_{\text{OUTCO}}$	2.000	4.880	2.000	5.241	2.000	6.004	ns

**Table 6–70. EP1SGX40 Row Pin Regional Clock External I/O Timing Parameters**

Symbol	-5 Speed Grade		-6 Speed Grade		-7 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{INSU}}$	2.398		2.567		2.938		ns
$t_{\text{INH}}$	0.000		0.000		0.000		ns
$t_{\text{OUTCO}}$	2.000	4.932	2.000	5.336	2.000	6.112	ns
$t_{\text{INSUPLL}}$	1.126		1.186		1.352		ns
$t_{\text{INHPLL}}$	0.000		0.000		0.000		ns
$t_{\text{OUTCOPLL}}$	0.500	2.304	0.500	2.427	0.500	2.765	ns

**Table 6–71. EP1SGX40 Row Pin Global Clock External I/O Timing Parameters (Part 1 of 2)**

Symbol	-5 Speed Grade		-6 Speed Grade		-7 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{INSU}}$	1.965		2.128		2.429		ns
$t_{\text{INH}}$	0.000		0.000		0.000		ns

**Table 6–82. Stratix GX Maximum Input Clock Rate for CLK[0, 2, 9, 11] Pins & FPLL[8..7]CLK Pins**

I/O Standard	-5 Speed Grade	-6 Speed Grade	-7 Speed Grade	Unit
LVTTL	422	422	390	MHz
2.5 V	422	422	390	MHz
1.8 V	422	422	390	MHz
1.5 V	422	422	390	MHz
LVC MOS	422	422	390	MHz
GTL	300	250	200	MHz
GTL+	300	250	200	MHz
SSTL-3 class I	400	350	300	MHz
SSTL-3 class II	400	350	300	MHz
SSTL-2 class I	400	350	300	MHz
SSTL-2 class II	400	350	300	MHz
SSTL-18 class I	400	350	300	MHz
SSTL-18 class II	400	350	300	MHz
1.5-V HSTL class I	400	350	300	MHz
1.5-V HSTL class II	400	350	300	MHz
1.8-V HSTL class I	400	350	300	MHz
1.8-V HSTL class II	400	350	300	MHz
3.3-V PCI	422	422	390	MHz
3.3-V PCI-X 1.0	422	422	390	MHz
Compact PCI	422	422	390	MHz
AGP 1×	422	422	390	MHz
AGP 2×	422	422	390	MHz
CTT	300	250	200	MHz
Differential HSTL	400	350	300	MHz
LVDS	717	717	640	MHz
LVPECL	717	717	640	MHz
PCML	400	375	350	MHz
HyperTransport technology	717	717	640	MHz

**Table 6–83. Stratix GX Maximum Input Clock Rate for CLK[1, 3, 8, 10] Pins (Part 1 of 2)**

I/O Standard	-5 Speed Grade	-6 Speed Grade	-7 Speed Grade	Unit
LVTTL	422	422	390	MHz
2.5 V	422	422	390	MHz

**Table 6–92. Fast PLL Specifications for -7 & -8 Speed Grades (Part 2 of 2)**

Symbol	Parameter	Min	Max	Unit
$t_{DUTY}$	Duty cycle for $DIFFIO\ 1 \times CLKOUT$ pin (3)	45	55	%
$t_{JITTER}$	Period jitter for $DIFFIO$ clock out (3)		$\pm 80$	ps
	Period jitter for internal global or regional clock		$\pm 100$ ps for $>200$ MHz $outclk$ $\pm 20$ mUI for $<200$ MHz $outclk$	ps or mUI
$t_{LOCK}$	Time required for PLL to acquire lock	10	100	$\mu$ s
$m$	Multiplication factors for $m$ counter (4)	1	32	Integer
$l0, l1, g0$	Multiplication factors for $l0, l1$ , and $g0$ counter (4), (5)	1	32	Integer
$t_{ARESET}$	Minimum pulse width on $areset$ signal	10		ns

**Notes to Tables 6–91 & 6–92:**

- (1) See “Maximum Input & Output Clock Rates” on page 6–54.
- (2) When using the SERDES, high-speed differential I/O mode supports a maximum output frequency of 210 MHz to the global or regional clocks (that is, the maximum data rate 840 Mbps divided by the smallest SERDES J factor of 4).
- (3) This parameter is for high-speed differential I/O mode only.
- (4) These counters have a maximum of 32 if programmed for 50/50 duty cycle. Otherwise, they have a maximum of 16.
- (5) High-speed differential I/O mode supports  $W = 1$  to 16 and  $J = 4, 7, 8$ , or 10.

## DLL Jitter

Table 6–93 reports the jitter for the DLL in the DQS phase-shift reference circuit.

**Table 6–93. DLL Jitter for DQS Phase Shift Reference Circuit**

Frequency (MHz)	DLL Jitter (ps)
197 to 200	$\pm 100$
160 to 196	$\pm 300$
100 to 159	$\pm 500$